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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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# 2SC4965

# Silicon NPN Epitaxial



ADE-208-006A (Z) 2nd. Edition Mar. 2001

#### **Application**

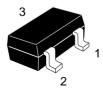
VHF / UHF RF switch

#### **Features**

- Low Ron and high performance for RF switch.
- Capable of high density mounting.

#### Outline

**CMPAK** 



- 1. Emitter
- 2. Base
- 3. Collector

Note: Marking is "YV-".

# 2SC4965

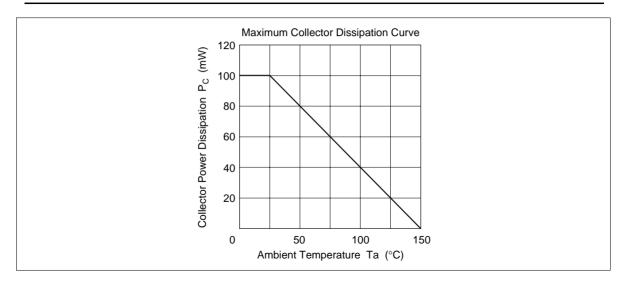
# **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	12	V
Collector to emitter voltage	$V_{\text{CEO}}$	8	V
Emitter to base voltage	$V_{EBO}$	3	V
Collector current	I <sub>c</sub>	100	mA
Collector power dissipation	P <sub>c</sub>	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

# **Electrical Characteristics** (Ta = 25°C)

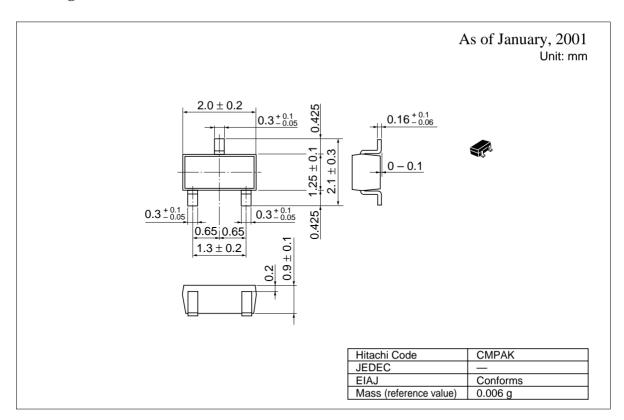
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	12	_	_	V	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$
Collector cutoff current	I <sub>CBO</sub>		_	10	μA	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0
	I <sub>CEO</sub>	_	_	1	mA	$V_{CE} = 8 \text{ V}, R_{BE} =$
Emitter cutoff current	I <sub>EBO</sub>	_	_	10	μΑ	$V_{EB} = 3 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub>	100	250	600		$V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	150	300	mV	$I_C = 80 \text{ mA}, I_B = 5 \text{ mA}$
Collector output capacitance	Cob	_	1.9	1.6	pF	$V_{CB} = 5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
On resistance	Ron	_	1.2	_		I <sub>B</sub> = 2.5 mA, f = 1 kHz

See characteristic curves of 2SC4964.



# 2SC4965

# **Package Dimensions**



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